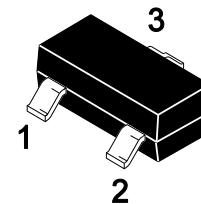




## Features

- $V_{DS}=-30V$ ,  $I_D=-4.1A$   
 $R_{DS(on)}=50m\Omega$  (Typ.)@ $V_{GS}=-10V$
- High density cell design for ultra low  $R_{DS(ON)}$
- Low gate charge

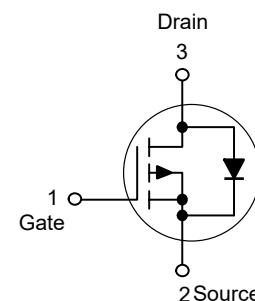
SOT-23



1. Gate 2. Source 3. Drain

**Marking: R7**

**Schematic Diagram**



## Applications

- Load Switch and in PWM Applications

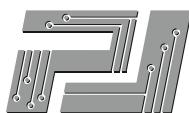
## Absolute Maximum Ratings

Ratings at  $T_A = 25^\circ C$  unless otherwise specified.

Parameter	Symbol	Value	Units
Drain-Source Voltage	$-V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$-I_D$	4.1	A
Power Dissipation	$P_D$	1.4	W
Junction and Storage Temperature Range	$T_J, T_{STG}$	150, -55 to 150	°C

## Thermal Characteristics

Parameter	Symbol	Typ.	Units
Maximum Junction-to-Ambient <sup>Note1</sup>	$R_{\theta JA}$	89	°C/W



# PJM3407PSA

## P Enhancement Field Effect Transistor

### Electrical Characteristics ( $T_A=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Static Characteristics</b>						
Drain-source breakdown voltage	$-V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0\text{V}, I_D = -250\mu\text{A}$	30			V
Zero gate voltage drain current	$-I_{\text{DSS}}$	$V_{DS} = -24\text{V}, V_{GS} = 0\text{V}$			1	$\mu\text{A}$
Gate-source leakage current	$I_{GSS}$	$V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$			$\pm 100$	nA
Drain-source on-resistance <sup>Note2</sup>	$R_{DS(\text{on})}$	$V_{GS} = -10\text{V}, I_D = -4.1\text{A}$		50	60	$\text{m}\Omega$
		$V_{GS} = -4.5\text{V}, I_D = -3\text{A}$		68	87	$\text{m}\Omega$
Gate threshold voltage <sup>Note2</sup>	$-V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	1	1.4	3	V
Forward transconductance <sup>Note2</sup>	$g_{FS}$	$V_{DS} = -5\text{V}, I_D = -4\text{A}$	5.5			S
<b>Dynamic Characteristics</b>						
Input capacitance	$C_{iss}$	$V_{DS} = -15\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$		700		pF
Output capacitance	$C_{oss}$			120		pF
Reverse transfer capacitance	$C_{rss}$			75		pF
<b>Switching Characteristics</b>						
Turn-on delay time	$t_{d(on)}$	$V_{GS} = -10\text{V}, V_{DS} = -15\text{V}, R_L = 3.6\Omega, R_{GEN} = 3\Omega$		8.6		ns
Turn-on rise time	$t_r$			5.0		ns
Turn-off delay time	$t_{d(off)}$			28.2		ns
Turn-off fall time	$t_f$			13.5		ns
<b>Source-Drain Diode Characteristics</b>						
Diode forward voltage	$V_{SD}$	$I_S = -1\text{A}, V_{GS} = 0\text{V}$			-1	V

#### Notes:

1. The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ . The value in any given application depends on the user's specific board design.
2. Pulse test: Pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .

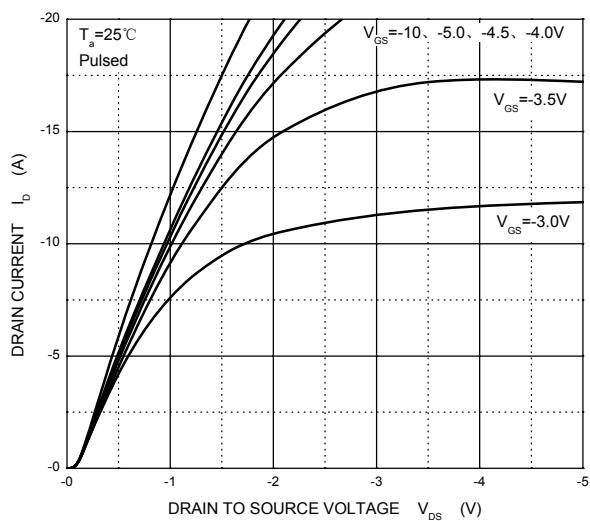


# PJM3407PSA

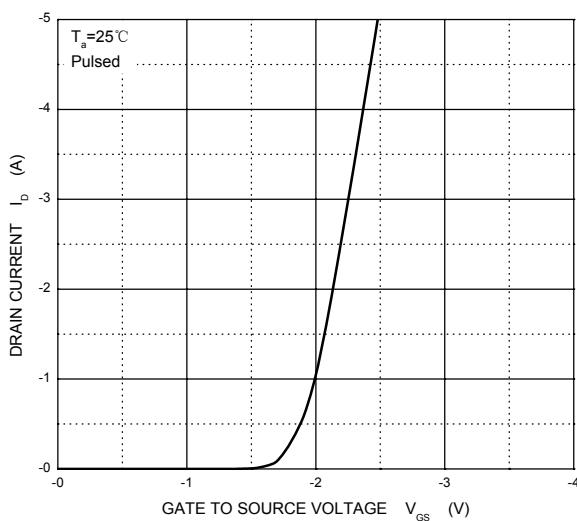
## P Enhancement Field Effect Transistor

### Typical Curves

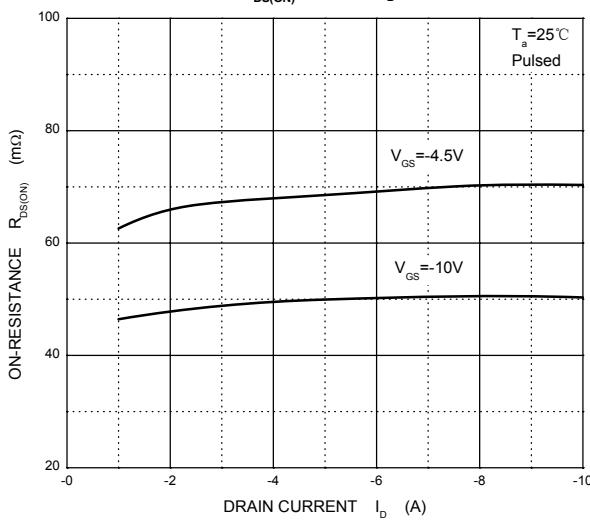
Output Characteristics



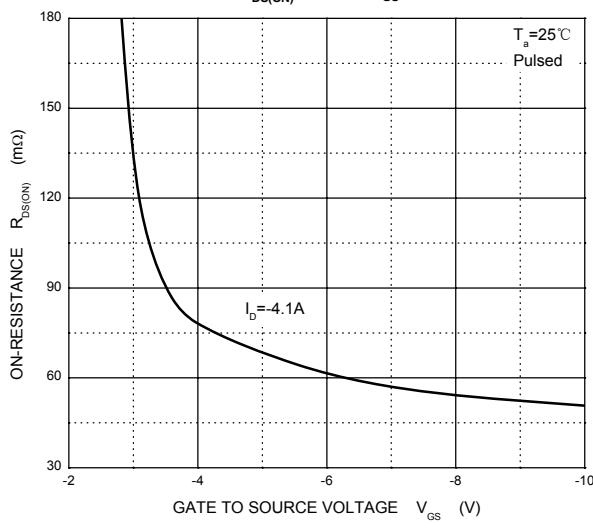
Transfer Characteristics



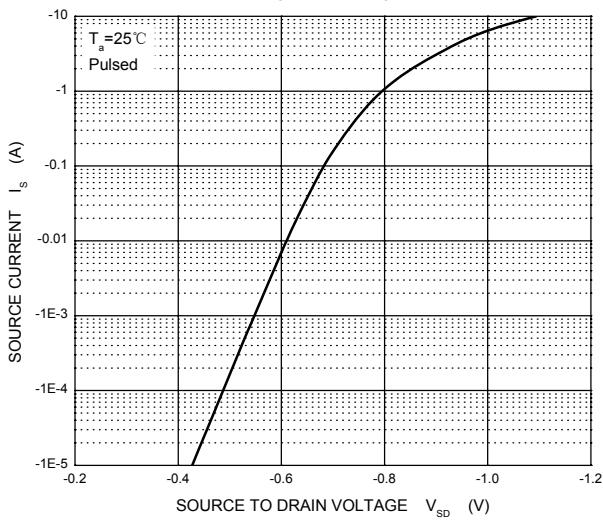
$R_{DS(ON)}$  —  $I_D$



$R_{DS(ON)}$  —  $V_{GS}$



$I_S$  —  $V_{SD}$



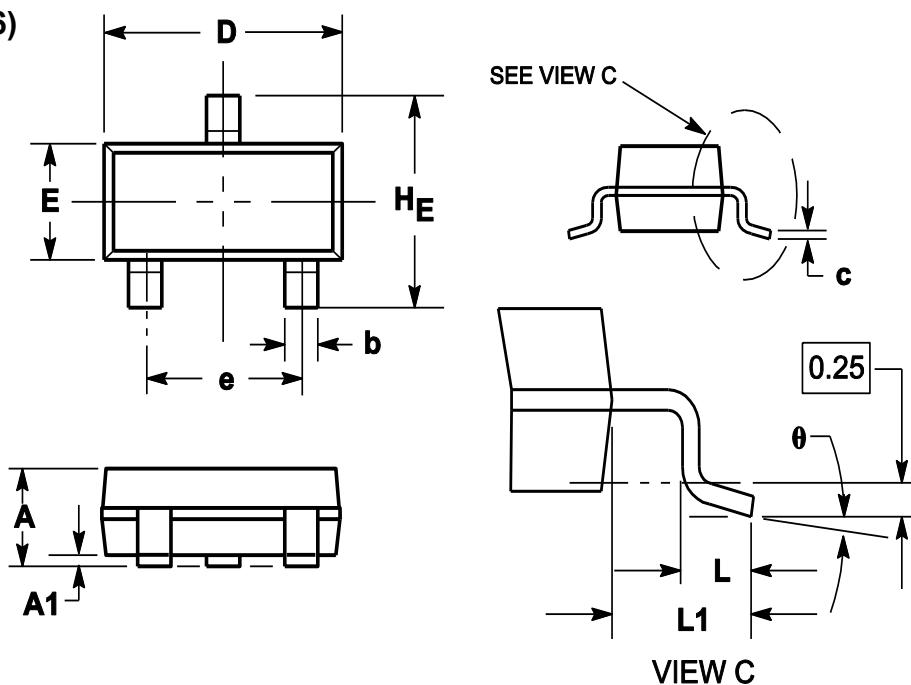


# PJM3407PSA

## P Enhancement Field Effect Transistor

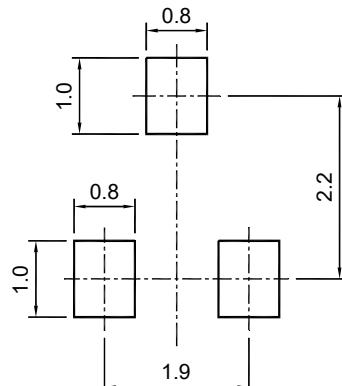
### Package Outline

SOT-23 (TO-236)



VIEW C

Symbol	Dimensions in millimeter		
	Min.	Typ.	Max.
A	0.900	1.025	1.150
A1	0.000	0.050	0.100
b	0.300	0.400	0.500
c	0.080	0.115	0.150
D	2.800	2.900	3.000
E	1.200	1.300	1.400
HE	2.250	2.400	2.550
e	1.800	1.900	2.000
L1	0.550REF		
L	0.300		0.500
θ	0°		8°



SOT-23 (TO-236)

Recommended soldering pad

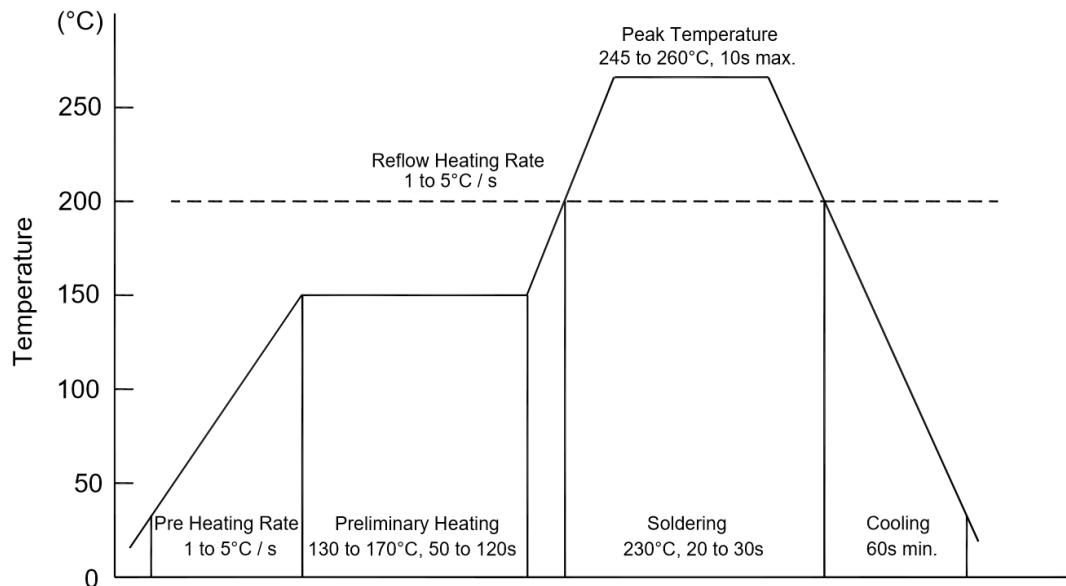
### Ordering Information

Device	Package	Shipping
PJM3407PSA	SOT-23	3000/Reel&Tape(7inch)



## Conditions of Soldering and Storage

### ◆ Recommended condition of reflow soldering



Recommended peak temperature is over 245 °C. If peak temperature is below 245 °C, you may adjust the following parameters:

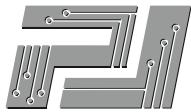
- Time length of peak temperature (longer)
- Time length of soldering (longer)
- Thickness of solder paste (thicker)

### ◆ Conditions of hand soldering

- Temperature: 370 °C
- Time: 3s max.
- Times: one time

### ◆ Storage conditions

- **Temperature**  
5 to 40 °C
- **Humidity**  
30 to 80% RH
- **Recommended period**  
One year after manufacturing



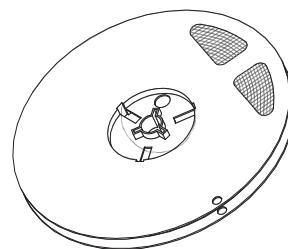
## Package Specifications

### ◆ The method of packaging

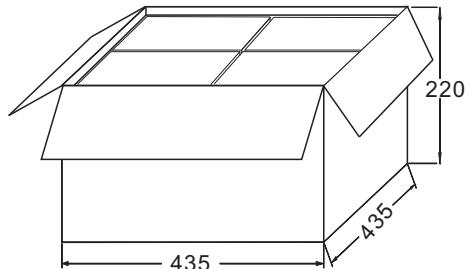
SOT-23 (TO-236)



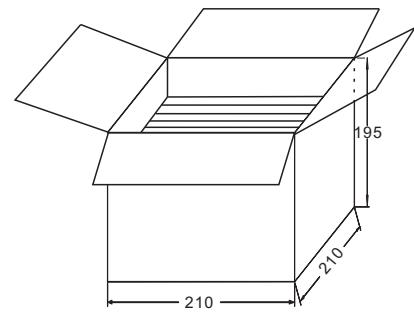
3,000 pcs per reel



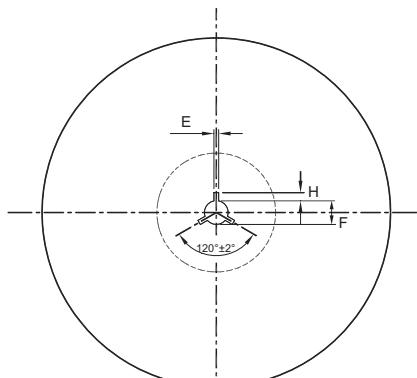
30,000 pcs per box  
10 reels per box



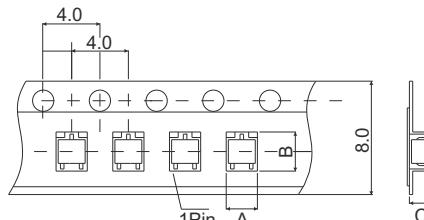
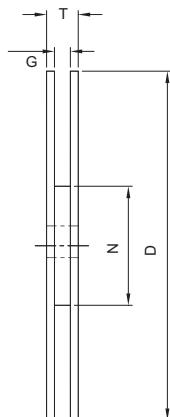
120,000 pcs per carton  
4 boxes per carton



### ◆ Embossed tape and reel data



Reel (7")



Tape (8mm)

Symbol	Value (unit: mm)
A	$3.15 \pm 0.1$
B	$2.7 \pm 0.1$
C	$1.25 \pm 0.1$
E	$2 \pm 0.5$
F	$13 \pm 0.5$
D	$178 \pm 2.0$
G	$8.4 \pm 1.5$
H	$4 \pm 0.5$
N	60
T	< 14.9

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